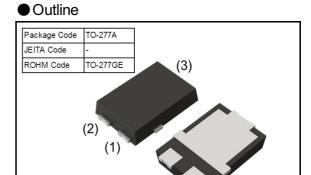


# RBQ5RSM10B

### Schottky Barrier Diode

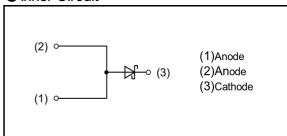
Data sheet

V <sub>R</sub>	100	V
l <sub>o</sub>	5	Α
I <sub>FSM</sub>	150	Α



Features
 High reliability
 Power mold type
 Low I<sub>R</sub>

Inner Circuit



ApplicationGeneral rectification

Packaging Specifications

Packing	Embossed Tape				
Reel Size(mm)	330				
Taping Width(mm)	12				
Quantity(pcs)	4000				
Taping Code	TL1				
Marking	BQ5RSM10B				

StructureSilicon epitaxial planar

● Absolute Maximum Ratings (T<sub>c</sub>=25°C unless otherwise specified)

0 1111111111111111111111111111111111111		' '		
Parameter	Symbol	Conditions	Limits	Unit
Repetitive peak reverse voltage	V <sub>RM</sub>	Duty≦0.5	100	V
Reverse voltage	V <sub>R</sub>	Reverse direct voltage	100	V
Average rectified forward current	lo	60Hz half sin waveform, resistive load, I <sub>0</sub> /2 per diode, T <sub>c</sub> =130°cMax.	5	Α
Peak forward surge current	I <sub>FSM</sub>	60Hz half sin waveform, non-repetitive, per diode, T <sub>a</sub> =25°c	150	Α
Junction temperature <sup>(1)</sup>	Tj	-	150	°C
Storage temperature	T <sub>stg</sub>	-	-55 ~ 150	°C

Note(1) To avoid occurrence of thermal runaway, actual board is to be designed to fulfill  $dP_d/dT_j < 1/R_{\theta JA}$ .

# Attention

Compared with PN junction diodes, Schottky Barrier Diode is generally high reverse current (IR). The reverse loss of the diode might increase as temperature increasing that causes heat-up and further IR. This phenomenon might end up the thermal destruction(thermal runaway). Therefore please give consideration to the reverse loss and the ambient temperature when using this product.

# ● Electrical Characteristics (T<sub>j</sub>=25°C unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward voltage	V <sub>F</sub>	I <sub>F</sub> =5A	-	0.64	0.70	V
Reverse current	I <sub>R</sub>	V <sub>R</sub> =100V	-	24	140	μA

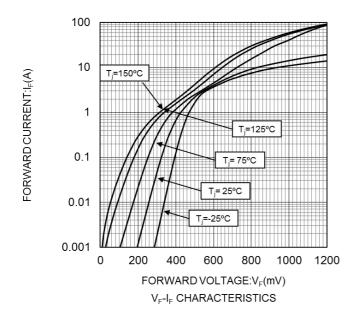
### Thermal Characteristics

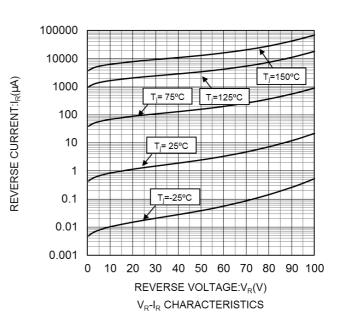
Parameter		Min.	Тур.	Max.	Unit
Thermal Resistance (Junction to case) <sup>(1)</sup> (2)	$R_{\theta JC}$	-	-	3.0	°C/W
Thermal Resistance (Junction to ambient) <sup>(1)</sup> (3)		-	-	90	°C/W

注 (1) Value is guaranteed by design.

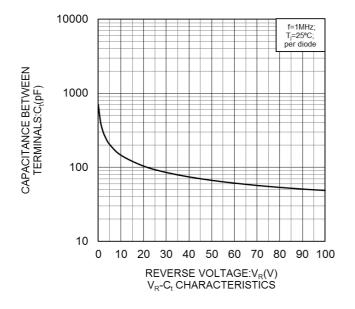
- (2) Transient dual interface measurement (TDIM) method.
- (3) Mounted on 50 x 50 x 1.6mm FR4 board, single-sided copper, 35µm thickness, reference footprint.

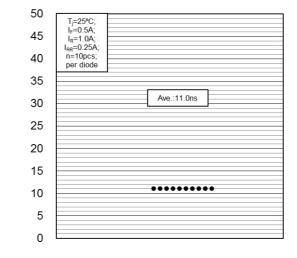
### Characteristic Curves





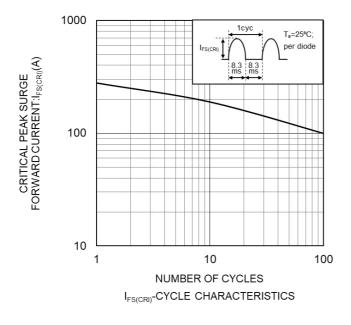
## Characteristic Curves

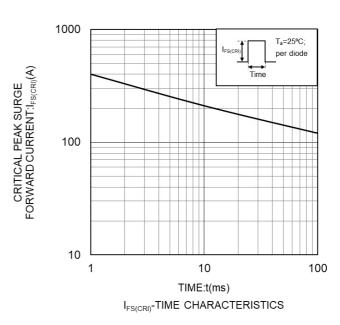




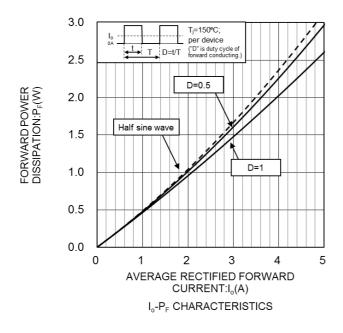
REVERSE RECOVERY TIME:t<sub>rr</sub>(ns)

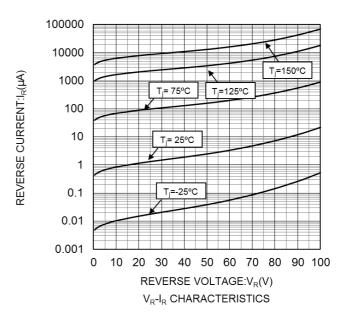
trr DISPERSION MAP

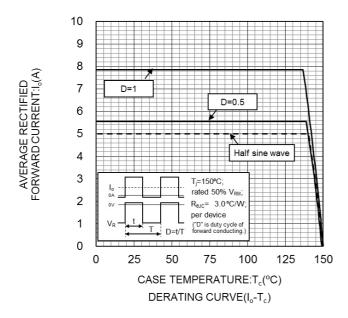




## Characteristic Curves

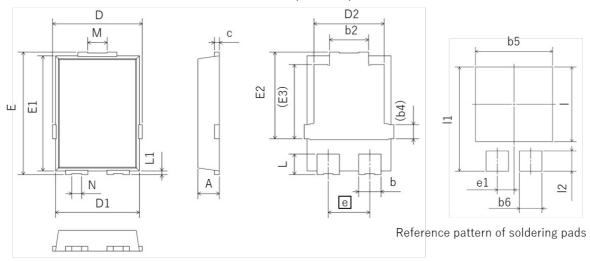






## Dimensions

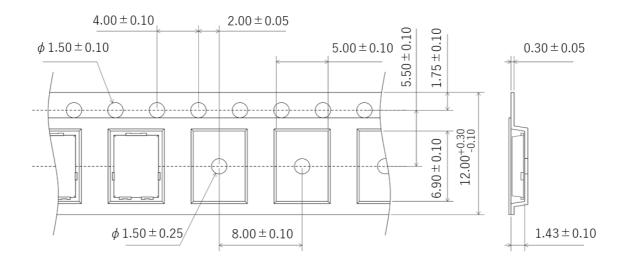
### TO-277A, (TO-277GE)



DIM	DIM Milimeters Max.		Inches		
DIM			Min.	Max.	
Α	1.00	1.20	0.039	0.047	
b	1.05	1.35	0.041	0.053	
b2	1.90	2.20	0.075	0.087	
b4	0.	75	0.0	30	
С	0.15	0.40	0.006	0.016	
D	4.45	4.75	0.175	0.187	
D1	4.25	4.35	0.167	0.171	
D2	3.40	3.70	0.134	0.146	
E	6.35	6.65	0.250	0.262	
E1	6.05	6.15	0.238	0.242	
E2	4.40	4.80	0.173	0.189	
E3	3.9	3.94		0.155	
е	2.	2.13		184	
L	0.94	1.24	0.037	0.049	
L1	0.05	0.35	0.002	0.014	
М	0.65	1.15	0.026	0.045	
N	0.25	0.75	0.010	0.030	

DIM	Milimeters	Inches
ואונט	Тур.	Тур.
b5	4.80	0.189
b6	1.40	0.055
e1	1.04	0.041
1	4.72	0.186
11	6.80	0.268
12	1.27	0.050

## ● Taping (Unit:mm)



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JAPAN	USA	EU	CHINA
CLASSⅢ	CLACCIII	CLASS II b	CL ACCIII
CLASSIV	CLASSII	CLASSⅢ	CLASSⅢ

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  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
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- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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**Rev.001** 

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